

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20160920004 Datasheet for DRV8839 Information Only

Date: 10/10/2016

To: Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE DRV8839DSSR **CUSTOMER PART NUMBER**

null

Technical details of this Product Change follow on the next page(s).

DCN N 201600200							0 1 10 2016			
	Number:	2016092000)4		PCN Date:			Oct. 10, 2016		
Title:	Datasheet for									
Customer Contact: PCN Manage		PCN Manager	<u>er</u>				ep	ot: Quality Services		
Chang	ge Type:		_			_	_			
	Assembly Site			Design		┞┝	4	Wafer Bump Site		
	Assembly Process		X			┡	╬	Wafer Bump Material		
	Assembly Material		Part number char		change	닏	╣	Wafer Bump Process		
	Mechanical Specifi		\sqsubseteq	Test Site		╠	╬	Wafer Fab Site		
Packing/Shipping/Labeling			Test Process			╠	╁	Wafer Fab Materials Wafer Fab Process		
Notification Details										
Description of Change: Texas Instruments Incorporated is announcing an information only notification etc.										
The product datasheet(s) is being updated as summarized below. The following change history provides further details.										
4	Instruments							DRV8839		
					SLVSBN4C -J	ANU	ARY	2013-REVISED AUGUST 2016		
01	Come Develoton D (Dec			· 6				D		
-	iges from Revision B (Dec	•						Page		
Deleted nFAULT from the Simplified Schematic										
Deleted the NC pins from the Pin Functions table										
• Changed the value of the capacitor on the VM pin from 10 μF to 0.1 μF in the <i>Typical Application Schematic</i>										
Changed the Layout Guidelines to clarify the guidelines for the VM pin										
Deleted references to TI's PowerPAD package and updated it with thermal pad where applicable										
Added the Receiving Notification of Documentation Updates section										
Changes from Revision A (January 2014) to Revision B										
Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section										
	atasheet number wi	ll be changing								
	ce Family		_	Change From:				Change To:		
DRV8	8839		>	SLVSBN4A				SLVSBN4C		
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/DRV8839										
Reason for Change:										
To more accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Changes to product identification resulting from this PCN:										
None.										
Product Affected:										
DRV8	8839DSSR				<u> </u>					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com